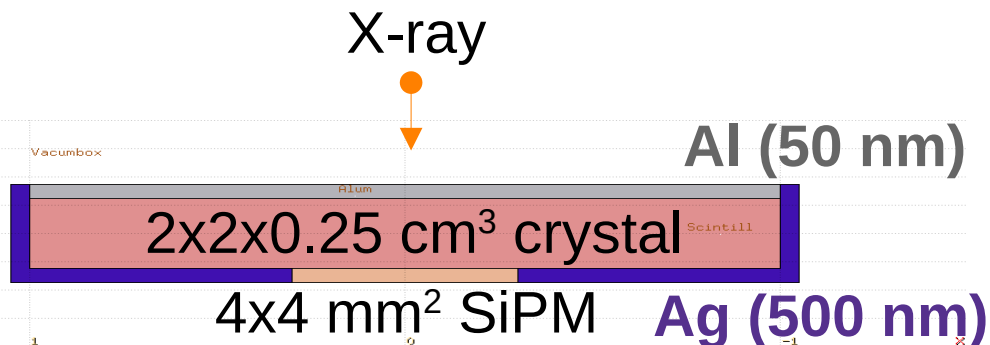


EPSI
1 July 2024

Single detection cell

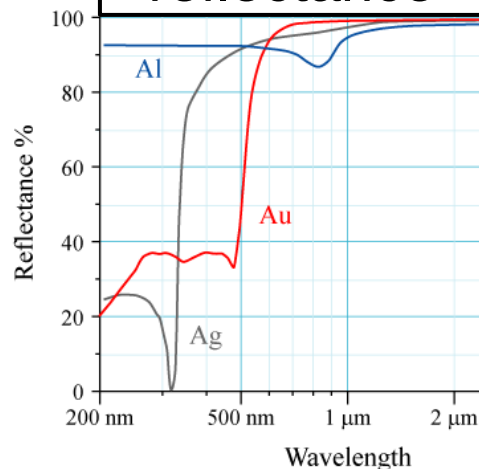
GOAL Maximize X-ray detection efficiency down to 1 keV



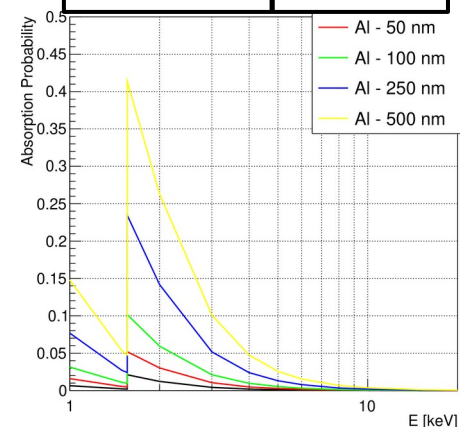
Key ingredient is “Wrapping”!

Metallic deposition (50-500 nm)

Large light reflectance



Small X-Ray absorption



Deposition via sputtering machine

A first measurement
with a simpler system

Description

- TIC crystal (**3.6x3.6x1.8 cm³ CsI:TI**)
- **S14160-4050HS** (4x4 mm², 50 μm cell)
- Attach a **SiPM** using a optical grease
- Wrap the whole crystal using **Vikuiti**
- Use Raffaello's **operational amplifier**
 - Sample **maximum** at oscilloscope

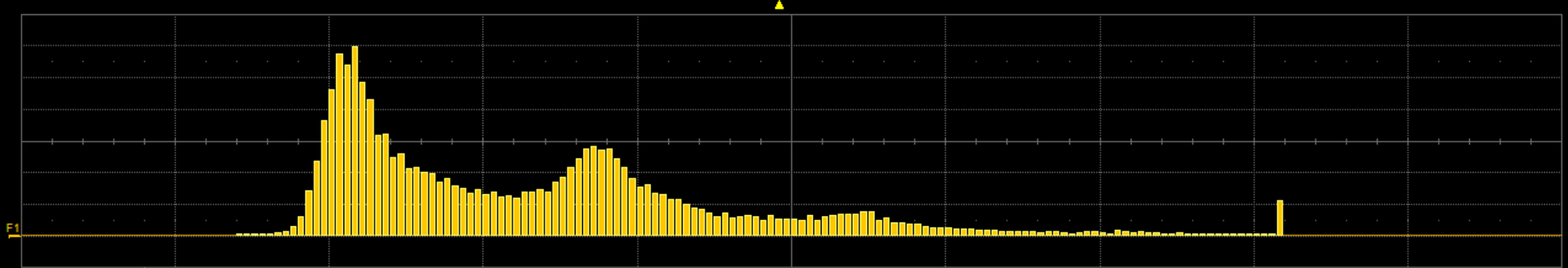
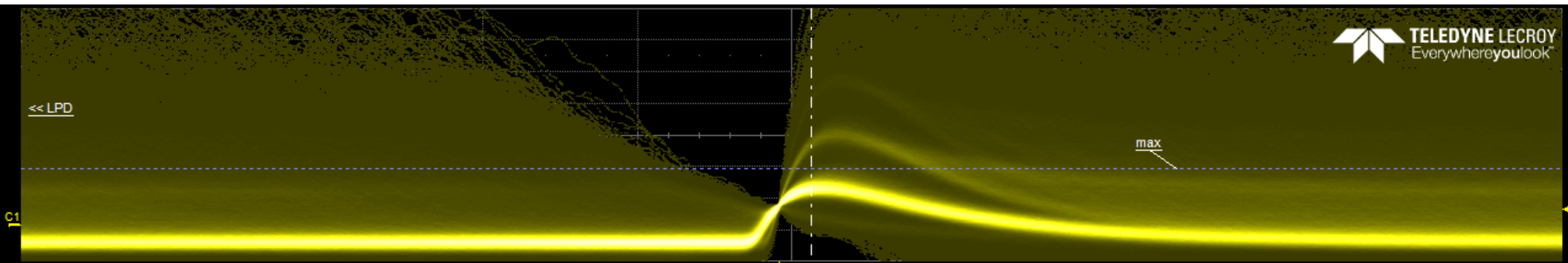
- ▶ Not 2.0x2.0x0.25 cm³
- ▶ Not the best candidate
- ▶ Not optical silicone
- ▶ Not Al/Ag deposition

NB The crystal was old and not healthy

GOALS:

- Test the overall experimental setup for future use
- Understand how many keV of X-ray are necessary to detect a scintillation photon in the SiPM sensor
 - 1) Need to see the dark count peaks
 - 2) Need two sources for calibration

Pedestal



C1	BwL DCTM	F1	hist(P1)
	2.00 mV/div		225 #/div
	-5.7000 mV		2.00 mV/div
			32.522 k#

Timebase	-8 ns	Trigger	C1 DC
	100 ns/div	Stop	1.00 mV
	2.5 kS	Edge	Positive
	2.5 GS/s		
X1=	20 ns		

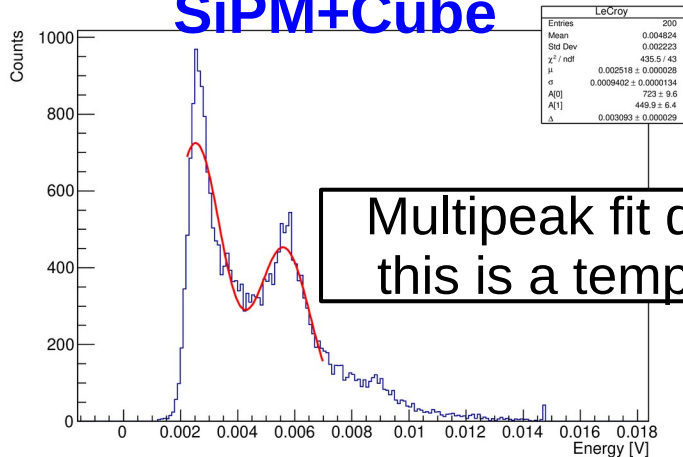
Pedestal

$$S[\textit{photon}] = \frac{S[\textit{mV}] - b}{a} + 1$$

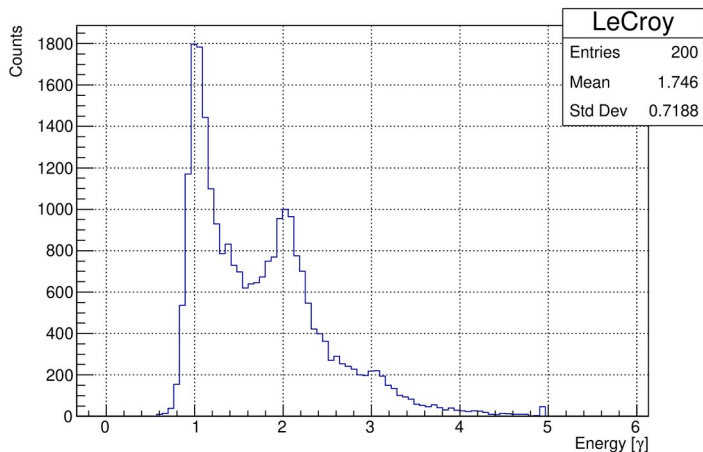
$$a = \Delta$$

$$b = \mu$$

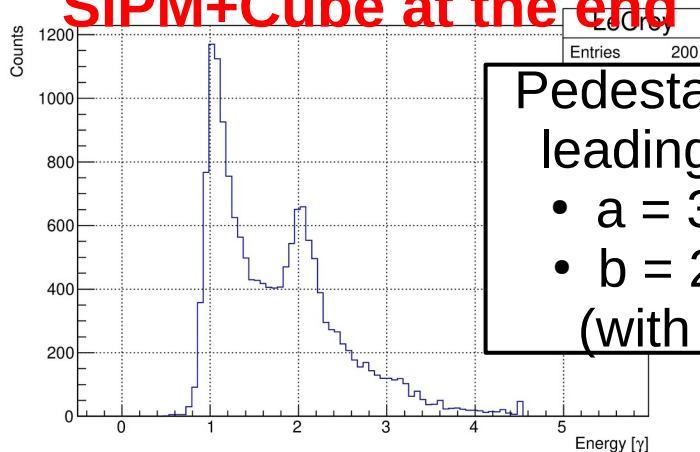
SiPM+Cube



Multipeak fit does not work well, this is a temporary workaround



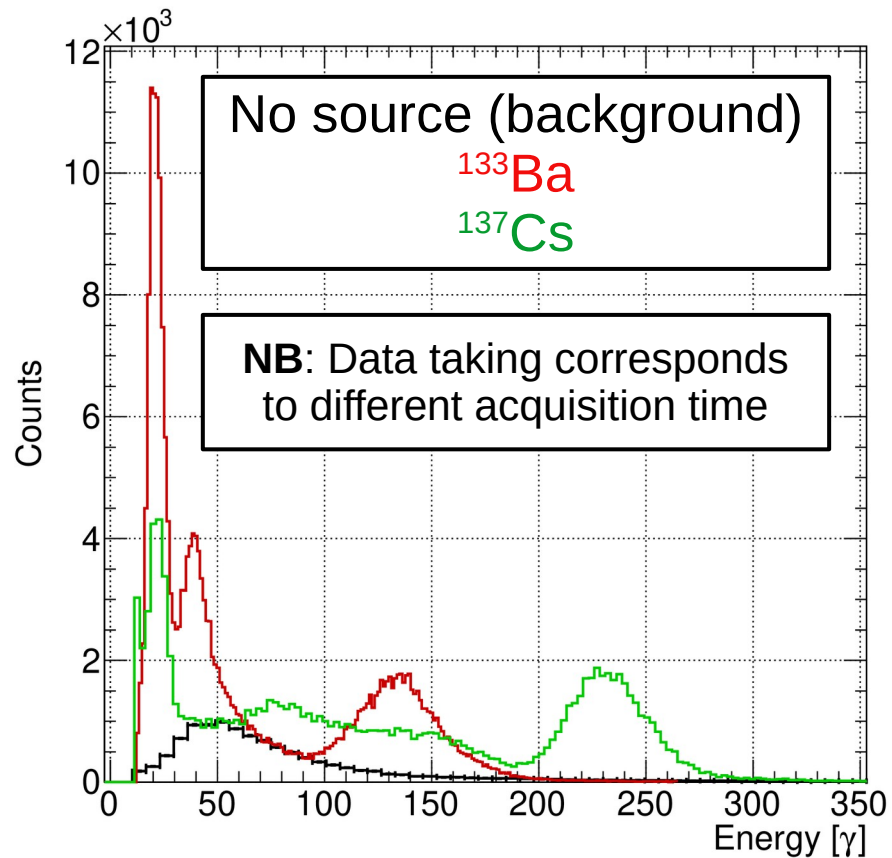
SiPM+Cube at the end



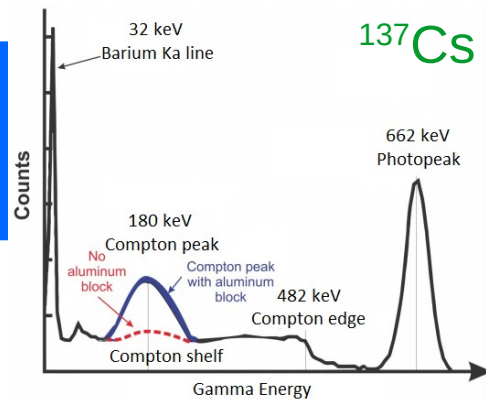
Pedestal fit with cube is stable, leading to these parameters:

- $a = 3.093_{-43}^{+153}$ mV/photon
- $b = 2.518_{-??}^{+151}$ mV [offset] (with 1-5% fit uncertainty)

Radioactive sources [#photon]



Energy scale calibration

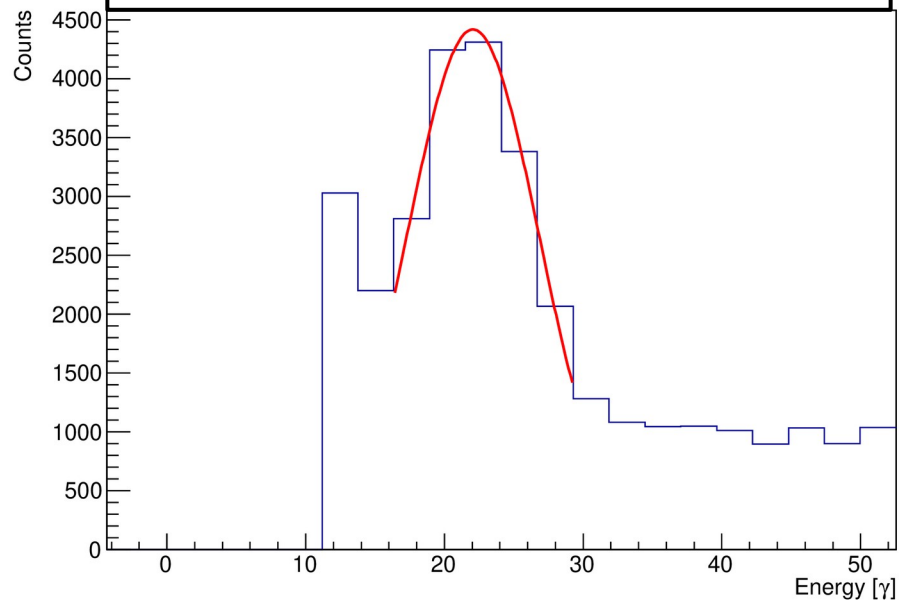


$$S[\text{keV}] = S[\text{photon}] * c + d$$

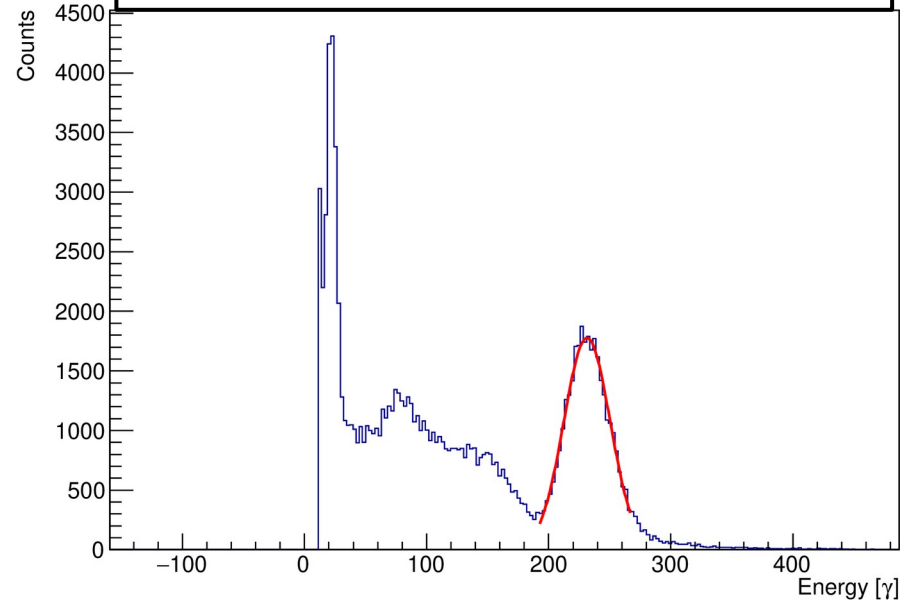
$$c = 3.0071023 \text{ keV / photon}$$

$$d = -34.263650 \text{ keV}$$

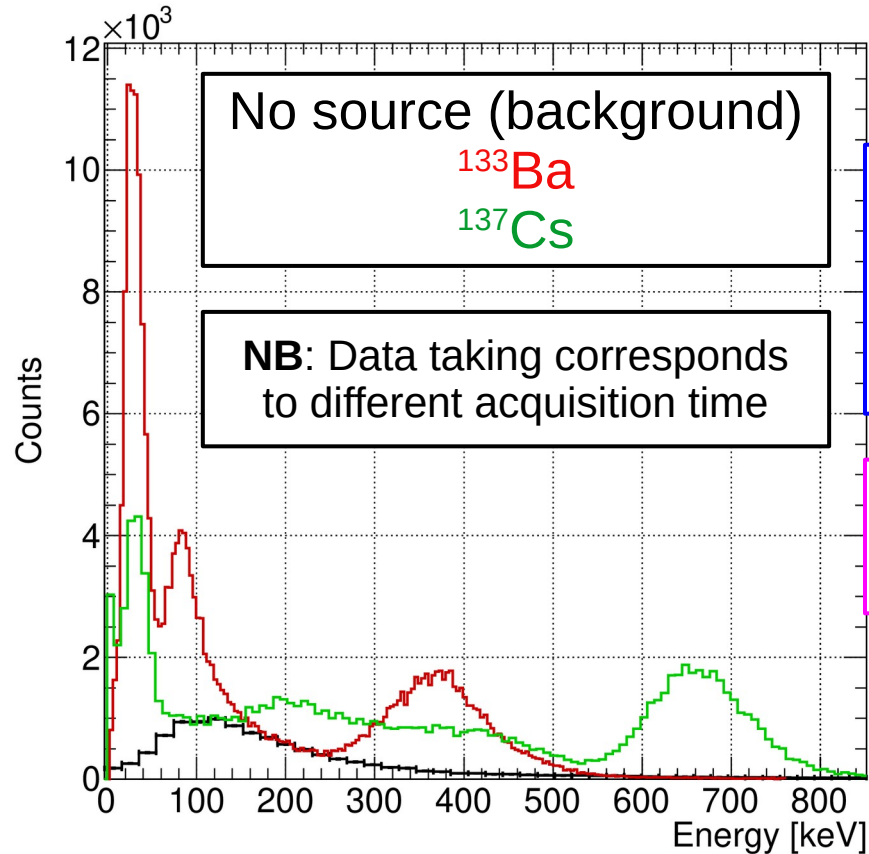
32.061 keV → 22.056 photons



661.655 keV → 231.425 photons



Radioactive sources [keV]



Once we calibrate with ^{137}Cs photoelectric peaks, ^{133}Ba photoelectric peaks have reasonable energies

^{137}Cs Compton structures are not well reproduced

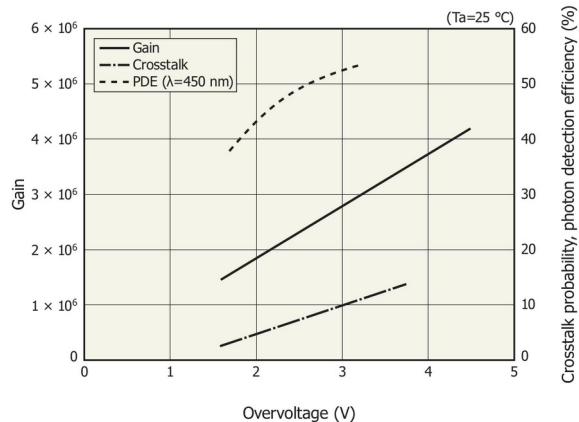
Dark count pile-up

$$S[\text{keV}] = S[\text{photon}] * c + d$$

From a simple estimation:

- Current 2.2 μA
- Overvoltage 4 V
- Gain 3.6×10^6 e/p

→ Dark Count = 3.8 MHz



$c = 3.0071023$ keV / photon
 $d = -34.263650$ keV
→ Dark Count = 11.4
(should we correct for CT?)

A detected dark count pile up of 11.4 photons corresponds to a sampling time of 3 μs , which is larger than expected:

- 2.5 μs sampling after trigger
- 0.5 μs from trigger to maximum

First deposition attempts

Sputtering machine

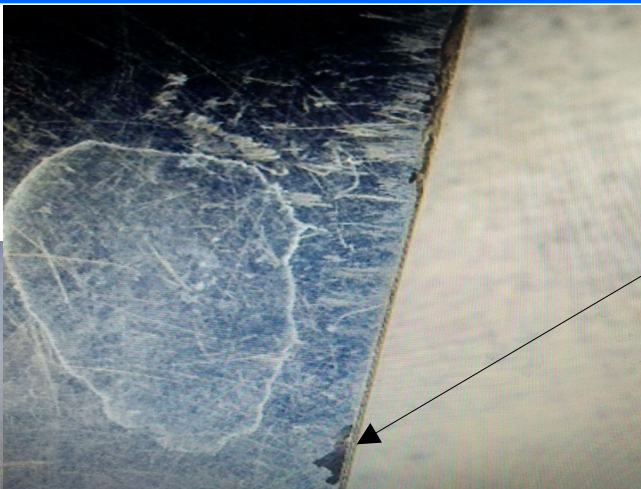
- It must be shared among experiments
- Each deposition requires about **1 day**
- Deposition is homogeneous for ~300 nm
- The sample is fixed using **carbon tape**
- Two depositions per crystal are necessary
- A **small window** must be done for SiPM

NB Deposition made on new crystals cut to $1.8 \times 1.8 \times 0.5 \text{ cm}^3$

GOALS:

- Test the deposition procedure
- Estimate deposition non-homogeneity
- Estimate contamination in deposition
- Understand if dead layers are formed
 - Measure the optical parameters

Al



Al deposition works well but:

- There are imperfections near the crystal corner
- Removing the tape does not leave clean edges



Glue SiPM before deposition?

- Clean glue edges?
- Number of SiPM?
 - Outgassing?

Ag



Ag deposition works well but it quickly oxidizes/corrodes!

- What generate corrosion?
- Need to treat CsI surface?
 - Need to passivate Ag?

Non-homogeneity and contamination

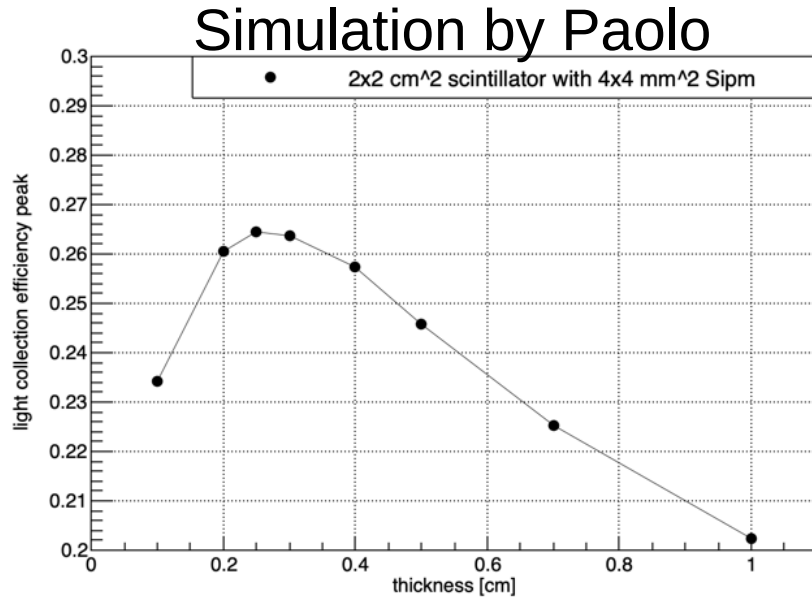
Non-homogeneity:

- SEM → Cannot access it!

Contamination:

- RBS → Failed to detect O!
 - × Need of a Al/Ag deposition on a thinner, lighter, O-free substrate layer...
- XPS → No information yet
 - × This techniques works well but only for a few *nm* (incomplete information)

Optical parameters



Several parameters are necessary to tune the optical simulation:

- CsI self-absorption length
- Al and Ag reflectivity
- Surface roughness

However, it was not possible to measure any of them...

Activity Plan

Desposition

Open Problems

Ag

- Understand the origin of corrosion
 - Study a solution for this effect

Al and Ag

- Study a solution for crystal corner and SiPM edge imperfections
- Fix the SiPM gluing and LEMO soldering procedure on crystal
- Find a way to get contamination and non-homogeneity in metal

TO DO: Deposition

Al

- Estimate how collection efficiency changes with deposition depth

Interaction with crystals

- Understand if deposition changes crystal surface to become passive

Mechanics

- Implement a soft mechanics to test just one channel with source

Crystal and SiPM

TO DO: Crystals

CsI(Tl) and GAGG(Ce)

- Compare collection efficiency (and rise time) of the two crystals
- Measure how collection efficiency changes with surface polishing
- For GAGG(Ce), measure light yield change at low temperatures

I hope that order will be completed in a few weeks...

TO DO: SiPM

- Compare collection efficiency with different SiPM by Hamamatsu
- Measure how collection efficiency changes with overvoltage
 - Study a system to stabilize operating point vs temperature

We have already received new SiPM by Hamamatsu



Prototype (far future)

Idea: Prototype

- Build a small prototype (5-10 channels) to be tested [LABEC?]

TO DO: Prototype

- Build a simple mechanics compliant with fragility of Al/Ag
- Study/Buy electronics for front-end and data acquisition

Back Up

^{137}Cs

	Energy (keV)	Photons (per 100 disint.)
$\gamma_{1,0}(\text{Ba})$	283,46 (7)	0,0006 (1)
$\gamma_{2,1}(\text{Ba})$	378,20 (7)	0,0000106 (9)
$\gamma_{2,0}(\text{Ba})$	661,655 (3)	85,01 (20)

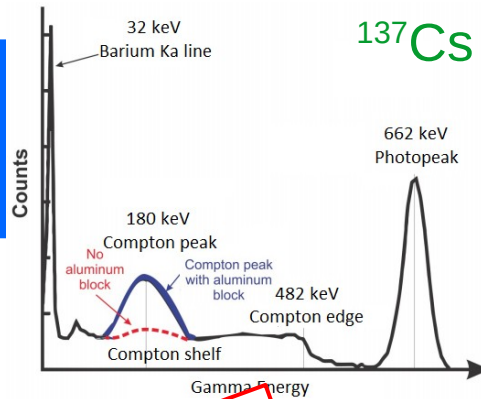
		Energy (keV)	Photons (per 100 disint.)	
XL	(Ba)	3,9544 - 5,8104	0,919 (16)	
XK α_2	(Ba)	31,8174	1,99 (4)	} K α
XK α_1	(Ba)	32,1939	3,66 (6)	
XK β_3	(Ba)	36,3045	} 1,078 (20)	} K' β_1
XK β_1	(Ba)	36,3786		
XK β_5''	(Ba)	36,654		
XK β_2	(Ba)	37,258	} 0,272 (8)	} K' β_2
XK β_4	(Ba)	37,312		
XK $O_{2,3}$	(Ba)	37,425		

^{133}Ba

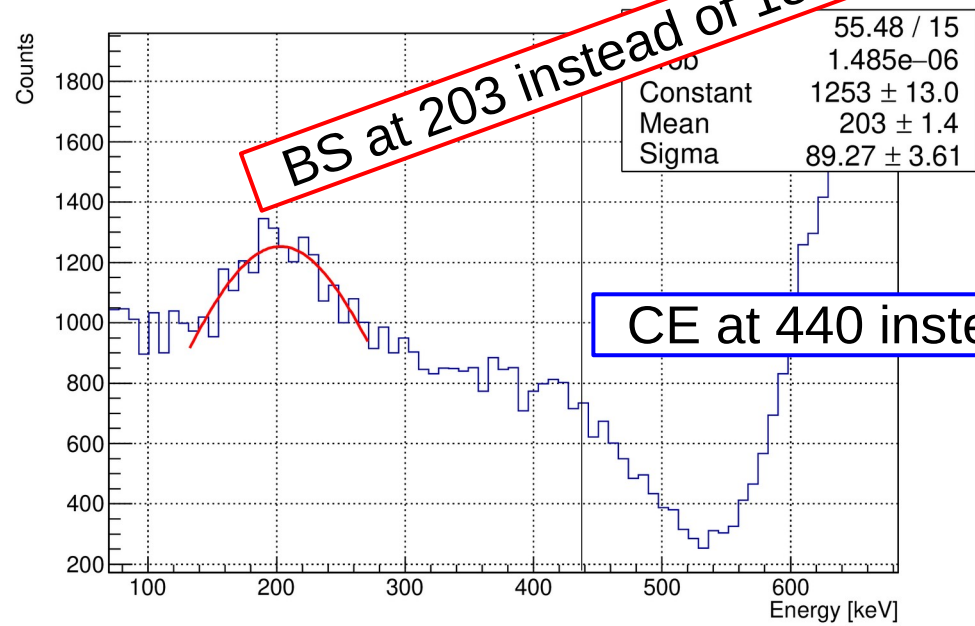
		Energy (keV)	Photons (per 100 disint.)	
XL	(Cs)	3,7946 - 5,5525	15,87 (26)	
XK α_2	(Cs)	30,6254	33,8 (4)	} K α
XK α_1	(Cs)	30,9731	62,4 (7)	
XK β_3	(Cs)	34,9197	} 18,24 (29)	} K' β_1
XK β_1	(Cs)	34,9873		
XK β_5''	(Cs)	35,252		
XK β_2	(Cs)	35,822	} 4,45 (12)	} K' β_2
XK β_4	(Cs)	35,907		
XK $O_{2,3}$	(Cs)	35,972		

	Energy (keV)	Photons (per 100 disint.)
$\gamma_{4,3}$ (Cs)	53,1622 (18)	2,14 (6)
$\gamma_{2,1}$ (Cs)	79,6142 (19)	2,63 (19)
$\gamma_{1,0}$ (Cs)	80,9979 (11)	33,31 (30)
$\gamma_{2,0}$ (Cs)	160,6121 (16)	0,638 (6)
$\gamma_{3,2}$ (Cs)	223,2368 (13)	0,450 (5)
$\gamma_{4,2}$ (Cs)	276,3989 (12)	7,13 (6)
$\gamma_{3,1}$ (Cs)	302,8508 (5)	18,31 (11)
$\gamma_{4,1}$ (Cs)	356,0129 (7)	62,05 (19)
$\gamma_{3,0}$ (Cs)	383,8485 (12)	8,94 (6)

Model II Validation



$$S[keV] = S[photon] * c + d$$

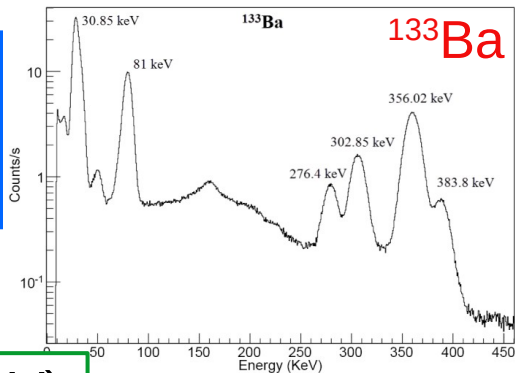


BS at 203 instead of 180 keV!

CE at 440 instead of 482 keV!

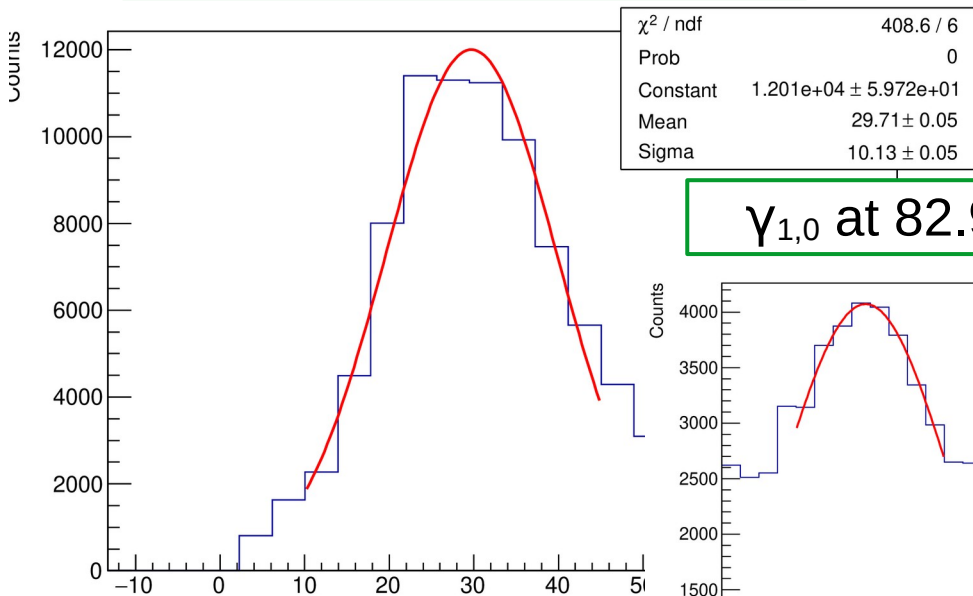
...geometric effect?

Model II Validation

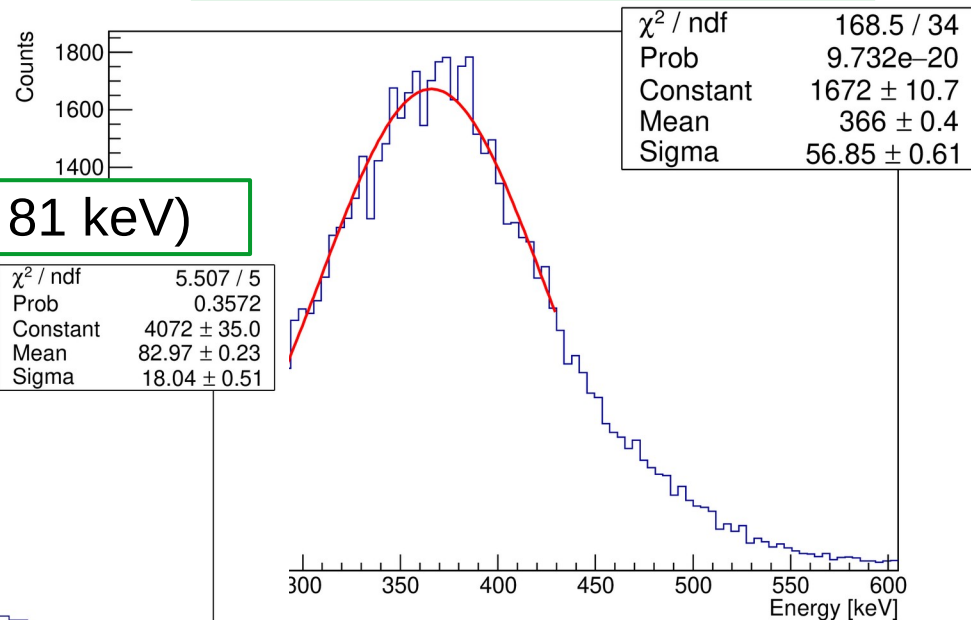


$$S[\text{keV}] = S[\text{photon}] * c + d$$

K α at 29.71 (vs 30.85 keV)



$\gamma_{3.0} * \gamma_{4.1}$ at 366 (vs 359 keV)



$\gamma_{1,0}$ at 82.97 (vs 81 keV)

